

LOW SKEW, 1-TO-4, DIFFERENTIAL-TO-HSTL FANOUT BUFFER

ICS8523

Description



The ICS8523 is a low skew, high performance 1-to-4 Differential-to-HSTL fanout buffer and a member of the HiPerClockS™family of High Performance Clock Solutions from IDT. The ICS8523 has two selectable clock inputs. The CLK, CLK pair can accept most

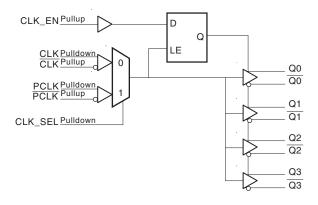
standard differential input levels. The PCLK, PCLK pair can accept LVPECL, CML, or SSTL input levels. The clock enable is internally synchronized to eliminate runt pulses on the outputs during asynchronous assertion/deassertion of the clock enable pin.

Guaranteed output and part-to-part skew characteristics make the ICS8523 ideal for those applications demanding well defined performance and repeatability.

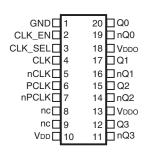
Features

- Four differentialoutput HSTL compatible outputs
- Selectable differential CLK, CLK or LVPECL clock inputs
- CLK, CLK pair can accept the following differential input levels: LVPECL, LVDS, HSTL, HCSL, SSTL
- PCLK, PCLK pair can accept the following differential input levels: LVPECL, CML, SSTL
- Maximum output frequenc: 650MHz
- Translates any single-ended input signal to HSTL levels with resistor bias on CLK input
- Output skew: 30ps (maximum)
- Part-to-part skew: 200ps (maximum)
- 3.3V core, 1.8V output operating supply
- 0°C to 70°C ambient operating temperature
- Available in both standard (RoHS 5) and lead-free (RoHS 6) packages

Block Diagram



Pin Assignment



ICS8523
20-Lead TSSOP
6.5mm x 4.4mm x 0.925mm
package body
G Package
Top View

Table 1. Pin Descriptions

Number	Name	T	уре	Description
1	GND	Power		Power supply ground.
2	CLK_EN	Input	Pullup	Synchronizing clock enable. When HIGH, clock outputs follow clock input. When LOW, Qx outputs are forced low, \overline{Qx} outputs are forced high. LVCMOS / LVTTL interface levels.
3	CLK_SEL	Input	Pulldown	Clock select input. When HIGH, selects differential PCLK, PCLK inputs. When LOW, selects CLK, CLK inputs. LVCMOS / LVTTL interface levels.
4	CLK	Input	Pulldown	Non-inverting differential clock input.
5	CLK	Input	Pullup	Inverting differential clock input.
6	CLK	Input	Pulldown	Non-inverting differential LVPECL clock input.
7	CLK	Input	Pullup	Inverting differential LVPECL clock input.
8, 9	nc	Unused		No connect.
10	V_{DD}	Power		Positive supply pin.
11, 12	Q3, Q3	Output		Differential output pair. HSTL interface levels.
13, 18	V_{DDO}	Power		Output supply pins.
14, 15	<u>Q2</u> , Q2	Output		Differential output pair. HSTL interface levels.
16, 17	Q1, Q1	Output		Differential output pair. HSTL interface levels.
19, 20	Q0 , Q0	Output		Differential output pair. HSTL interface levels.

NOTE: Pullup and Pulldown refer to intenal input resistors. See Table 2, Pin Characteristics, for typical values.

Table 2. Pin Characteristics

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
C _{IN}	Input Capacitance			4		pF
R _{PULLUP}	Input Pullup Resistor			51		kΩ
R _{PULLDOWN}	Input Pulldown Resistor			51		kΩ

Function Tables

Table 3A. Control Input Function Table

	Inputs	Out	puts	
CLK_EN	CLK_SEL	Selected Source	Q0:Q3	Q0:Q3
0	0	CLK, CLK	Disabled; LOW	Disabled; HIGH
0	1	PCLK, PCLK	Disabled; LOW	Disabled; HIGH
1	0	CLK, CLK	Enabled	Enabled
1	1	PCLK, PCLK	Enabled	Enabled

After CLK_EN switches, the clock outputs are disabled or enabled following a rising and falling input clock edge as shown in Figure 1. In the active mode, the state of the outputs are a function of the CLK, $\overline{\text{CLK}}$ and PCLK, $\overline{\text{PCLK}}$ inputs as described in Table 3B.

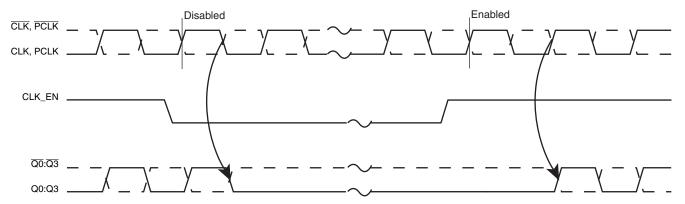


Figure 1. CLK_EN Timing Diagram

Table 3B. Clock Input Function Table

Inputs		Out	puts		
CLK or PCLK	CLK or PCLK	Q[0:3]	Q[0:3]	Input to Output Mode	Polarity
0	0	LOW	HIGH	Differential to Differential	Non-Inverting
1	1	HIGH	LOW	Differential to Differential	Non-Inverting
0	Baised; NOTE 1	LOW	HIGH	Single-Ended to Differential	Non-Inverting
1	Baised; NOTE 1	HIGH	LOW	Single-Ended to Differential	Non-Inverting
Baised; NOTE 1	0	HIGH	LOW	Single-Ended to Differential	Inverting
Baised; NOTE 1	1	LOW	HIGH	Single-Ended to Differential	Inverting

Absolute Maximum Ratings

NOTE: Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These ratings are stress specifications only. Functional operation of product at these conditions or any conditions beyond those listed in the *DC Characteristics* or *AC Characterisitcs* is not implied. Exposure to absolute maximum rating conditions for extended periods may affect product reliability.

Item	Rating
Supply Voltage, V _{DD}	4.6V
Inputs, V _I	-0.5V to V _{DD} + 0.5V
Outputs, I _O (LVPECL) Continous Current Surge Current	50mA 100mA
Package Thermal Impedance, θ_{JA}	73.2°C/W (0 lfpm)
Storage Temperature, T _{STG}	-65°C to 150°C

DC Electrical Characteristics

Table 4A. LVDS Power Supply DC Characteristics, $V_{DD} = 3.3V \pm 5\%$, $V_{DDO} = 1.8V \pm 0.2V$, $T_A = 0$ °C to 70°C

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V_{DD}	Positive Supply Voltage		3.135	3.3	3.465	V
V_{DDO}	Output Supply Voltage		1.6	1.8	2.0	V
I _{DD}	Power Supply Current				50	mA

Table 4B. LVCMOS/LVTTL DC Characteristics, $V_{DD} = 3.3V \pm 5\%$, $V_{DDO} = 1.8V \pm 0.2V$, $T_A = 0$ °C to 70°C

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
V _{IH}	Input High Voltage			2		V _{DD} + 0.3	٧
V _{IL}	Input Low Voltage			-0.3		0.8	V
	Input Lligh Current	CLK_EN	$V_{DD} = V_{IN} = 3.465V$			5	μA
Iн	Input High Current	CLK_SEL	$V_{DD} = V_{IN} = 3.465V$			150	μA
	Input Low Current	CLK_EN	V _{DD} = 3.465V, V _{IN} = 0V	-150			μA
I _{IL}	Input Low Current	CLK_SEL	V _{DD} = 3.465V, V _{IN} = 0V	-5			μΑ

Table 4C. Differential DC Characteristics, V_{DD} = 3.3V ± 5%, V_{DDO} = 1.8V ±0.2V, T_A = 0°C to 70°C

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
	Input High Current	CLK	$V_{DD} = V_{IN} = 3.465V$			5	μΑ
IH	Input High Current	CLK	$V_{DD} = V_{IN} = 3.465V$			150	μA
	In must I am Commant	CLK	V _{DD} = 3.465V, V _{IN} = 0V	-150			μΑ
IIL.	Input Low Current	CLK	V _{DD} = 3.465V, V _{IN} = 0V	-5			μΑ
V _{PP}	Peak-to-Peak Volta	ge		0.15		1.3	٧
V _{CMR}	Common Mode Inp NOTE 1, 2	ut Voltage;		0.5		V _{DD} – 0.85	V

NOTE 1: Common mode input voltage is defined as V_{IH} .

NOTE 2: For single-ended applications, the maximum input voltage for CLK, $\overline{\text{CLK}}$ is V_{DD} + 0.3V.

Table 4D. LVPECL DC Characteristics, $V_{DD} = 3.3V \pm 5\%$, $V_{DDO} = 1.8V \pm 0.2V$, $T_A = 0^{\circ}C$ to $70^{\circ}C$

Symbol	Parameter		Test Conditions	Minimum	Typical	Maximum	Units
	Input High Current	PCLK	$V_{DD} = V_{IN} = 3.465V$			5	μΑ
IН	Input High Current	PCLK	$V_{DD} = V_{IN} = 3.465V$			150	μΑ
	Input Low Current	PCLK	V _{DD} = 3.465V, V _{IN} = 0V	-150			μΑ
I _{IL}	Input Low Current	PCLK	V _{DD} = 3.465V, V _{IN} = 0V	-5			μΑ
V _{PP}	Peak-to-Peak Volta	ige		0.3		1.0	V
V _{CMR}	Common Mode Inp	ut Voltage;		1.5		V _{DD}	V

NOTE 1: Common mode input voltage is defined as V_{IH} .

NOTE 2: For single-ended applications, the maximum input voltage for CLK, $\overline{\text{CLK}}$ is V_{DD} + 0.3V.

Table 4E. HSTL DC Characteristics, $V_{DD} = 3.3V \pm 5\%$, $V_{DDO} = 1.8V \pm 0.2V$, $T_A = 0^{\circ}C$ to $70^{\circ}C$

Symbol	Parameter	Test Conditions	Minimum	Typical	Maximum	Units
V _{OH}	Output High Current; NOTE 1		0.9		1.4	V
V _{OL}	Output Low Current; NOTE 1		0		0.4	V
V _{OX}	Output Crossover Voltage		40% x (V _{OH} – V _{OL}) + V _{OL}		60% x (V _{OH} – V _{OL}) + V _{OL}	V
V _{SWING}	Peak-toPeak Output Voltage Swing		0.75		1.25	V

NOTE 1: Outputs termination with 50Ω to ground.

AC Electrical Characteristics

Table 5. AC Characteristics, $V_{DD} = 3.3V \pm 5\%$, $V_{DDO} = 1.8V \pm 0.2V$, $T_A = 0$ °C to 70°C

Parameter	Symbol	Test Conditions	Minimum	Typical	Maximum	Units
f _{MAX}	Output Frequency		1.0		650	MHz
t _{PD}	Propagation Delay; NOTE 1	<i>f</i> ≤ 650MHz			1.6	ns
tsk(o)	Output Skew; NOTE 2, 3				30	ps
tsk(pp)	Part-to-Part Skew; NOTE 3, 4				200	ps
t _R / t _F	Output Rise/Fall Time	20% to 80% @ 50MHz	250		700	ps
odc	Output Duty Cycle		45		55	%

All parameters measured at 500MHz unless noted otherwise.

NOTE 1: Measured from the differential input crossing point to the differential output crossing point.

NOTE 2: Defined as skew between outputs at the same supply voltage and with equal load conditions.

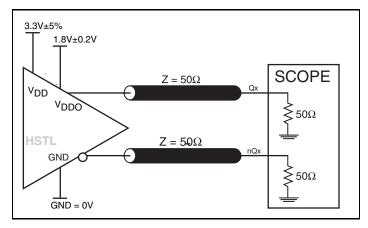
Measured at output differential cross points.

NOTE 3: This parameter is defined in accordance with JEDEC Standard 65.

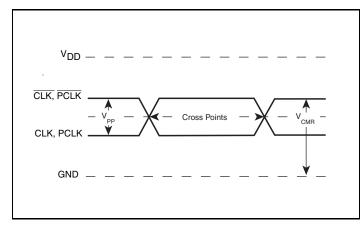
NOTE 4: Defined as skew between outputs on different devices operating at the same supply voltages and with equal load conditions.

Using the same type of inputs on each device, the outputs are measured at the differential cross points.

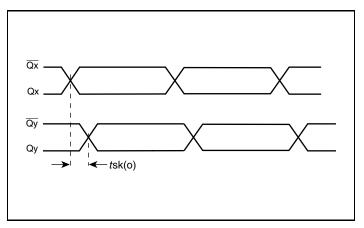
Parameter Measurement Information



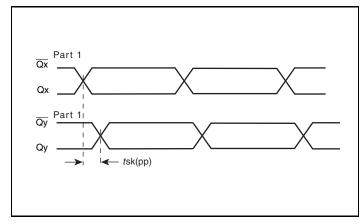
3.3V/1.8V Output Load AC Test Circuit



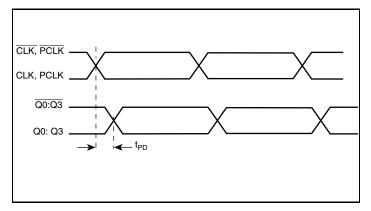
Differential Input Level



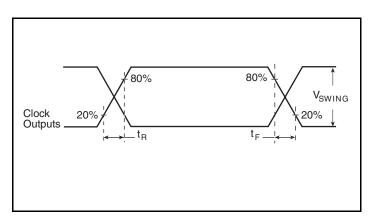
Output Skew



Part-to-Part Skew

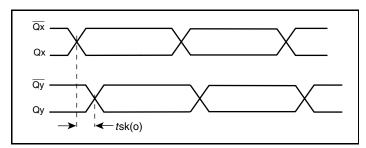


Propagation Delay



Output Rise/Fall Time

Parameter Measurement Information, continued



Output Duty Cycle/Pulse Width/Period

Application Information

Wiring the Differential Input to Accept Single Ended Levels

Figure 2 shows how the differential input can be wired to accept single ended levels. The reference voltage V_REF = $V_{DD}/2$ is generated by the bias resistors R1, R2 and C1. This bias circuit should be located as close as possible to the input pin. The ratio of R1 and R2 might need to be adjusted to position the V_REF in the center of the input voltage swing. For example, if the input clock swing is only 2.5V and $V_{DD} = 3.3V$, V_REF should be 1.25V and R2/R1 = 0.609.

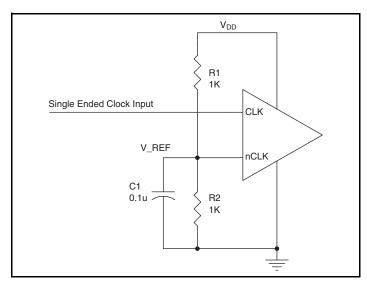


Figure 2. Single-Ended Signal Driving Differential Input

Differential Clock Input Interface

The CLK/ $\overline{\text{CLK}}$ accepts LVDS, LVPECL, LVHSTL, SSTL, HCSL and other differential signals. Both V_{SWING} and V_{OH} must meet the V_{PP} and V_{CMR} input requirements. *Figures 3A to 3E* show interface examples for the HiPerClockS CLK/ $\overline{\text{CLK}}$ input driven by the most common driver types. The input interfaces suggested here are

examples only. Please consult with the vendor of the driver component to confirm the driver termination requirements. For example, in Figure 2A, the input termination applies for IDT HiPerClockS LVHSTL drivers. If you are using an LVHSTL driver from another vendor, use their termination recommendation.

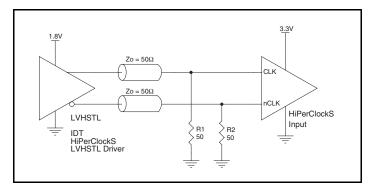


Figure 3A. HiPerClockS CLK/CLK Input Driven by an IDT HiPerClockS LVHSTLDriver

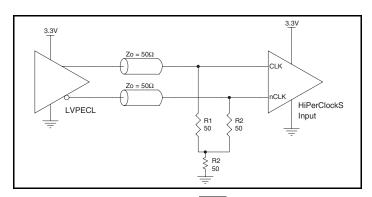


Figure 3B. HiPerClockS CLK/CLK Input
Driven by a 3.3V LVPECL Driver

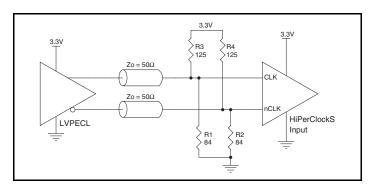


Figure 3C. HiPerClockS CLK/CLK Input
Driven by a 3.3V LVPECL Driver

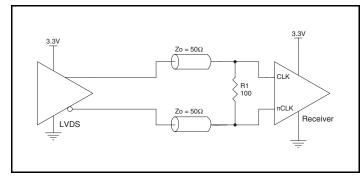


Figure 3D. HiPerClockS CLK/CLK Input Driven by a 3.3V LVDS Driver

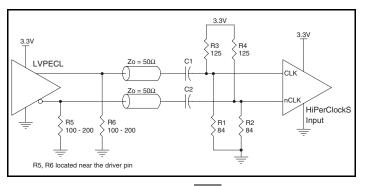


Figure 3E. HiPerClockS CLK/CLK Input Driven by a 3.3V LVPECL Driver with AC Couple

LVPECL Clock Input Interface

The PCLK /PCLK accepts LVPECL, CML, SSTL and other differential signals. Both V_{SWING} and V_{OH} must meet the V_{PP} and V_{CMR} input requirements. Figures 4A to 4E show interface examples for the HiPerClockS PCLK/PCLK input driven by the

most common driver types. The input interfaces suggested here are examples only. If the driver is from another vendor, use their termination recommendation. Please consult with the vendor of the driver component to confirm the driver termination requirements.

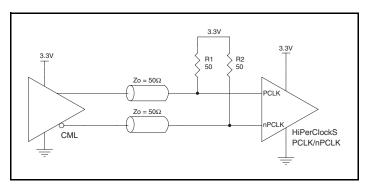


Figure 4A. HiPerClockS PCLK/PCLK Input
Driven by an Open Collector CML Driver

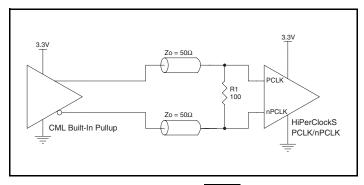


Figure 4B. HiPerClockS PCLK/PCLK Input
Driven by a Built-In Pullup CML Driver

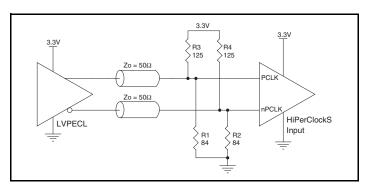


Figure 4C. HiPerClockS PCLK/nPCLK Input Driven by a 3.3V LVPECL Driver

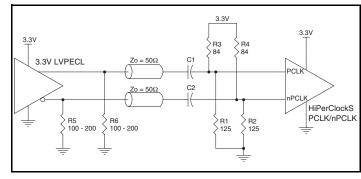


Figure 4D. HiPerClockS PCLK/PCLK Input Driven by a 3.3V LVPECL Driver with AC Couple

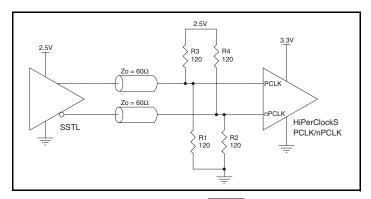


Figure 4E. HiPerClockS PCLK/PCLK Input Driven by an SSTL Driver

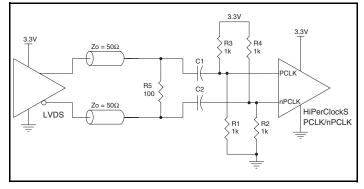


Figure 4F. HiPerClockS PCLK/PCLK Input Driven by a 3.3V LVDS Driver

Recommendations for Unused Input and Output Pins

Inputs:

LVCMOS Control Pins:

All control pins have internal pull-ups or pull-downs; additional resistance is not required but can be added for additional protection. A $1k\Omega$ resistor can be used.

CLK/CLK INPUT:

For applications not requiring the use of the differential input, both CLK and $\overline{\text{CLK}}$ can be left floating. Though not required, but for additional protection, a $1 k\Omega$ resistor can be tied from CLK to ground.

PCLK/PCLK INPUT:

For applications not requiring the use of a differential input, both the PCLK and \overline{PCLK} pins can be left floating. Though not required, but for additional protection, a $1k\Omega$ resistor can be tied from PCLK to ground.

Outputs:

HSTL Outputs

All unused LVHSTL outputs can be left floating. We recommend that there is no trace attached. Both sides of the differential output pair should either be left floating or terminated.

Schematic Example

Figure 5 shows a schematic example of the ICS8523. In this example, the input is driven by an IDT HiPerClockS HSTL driver. The decoupling capacitors should be physically located near the

power pin. For ICS8523, the unused clock outputs can be left floating.

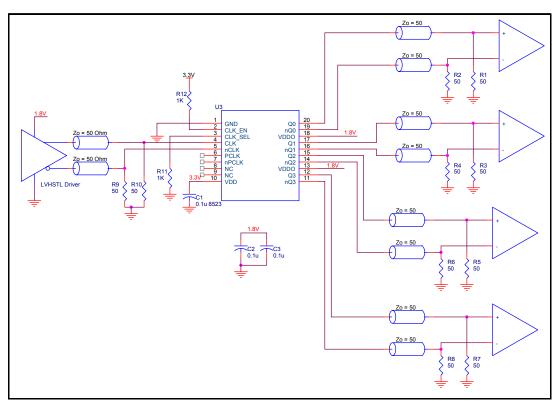


Figure 5. ICS8523 HSTL Buffer Schematic Example

Power Considerations

This section provides information on power dissipation and junction temperature for the ICS8523. Equations and example calculations are also provided.

1. Power Dissipation.

The total power dissipation for the ICS8523 is the sum of the core power plus the power dissipated in the load(s). The following is the power dissipation for $V_{DD} = 3.3V + 5\% = 3.465V$, which gives worst case results.

NOTE: Please refer to Section 3 for details on calculating power dissipated in the load.

- Power (core)_{MAX} = V_{DD MAX} * I_{DD MAX} = 3.465V * 50mA = 173.3mW
- Power (outputs)_{MAX} = 32.6mW/Loaded Output pair
 If all outputs are loaded, the total power is 4 x 32.6mW = 130.4mW

Total Power_MAX (3.465V, with all outputs switching) = 173.3mW + 130.4mW = 303.7mW

2. Junction Temperature.

Junction temperature, Tj, is the temperature at the junction of the bond wire and bond pad and directly affects the reliability of the device. The maximum recommended junction temperature for HiPerClockS devices is 125°C.

The equation for Tj is as follows: Tj = θ_{JA} * Pd_total + T_A

Tj = Junction Temperature

 θ_{JA} = Junction-to-Ambient Thermal Resistance

Pd_total = Total Device Power Dissipation (example calculation is in section 1 above)

 T_A = Ambient Temperature

In order to calculate junction temperature, the appropriate junction-to-ambient thermal resistance θ_{JA} must be used. Assuming a moderate air flow of 200 linear feet per minute and a multi-layer board, the appropriate value is 66.6°C/W per Table 6 below.

Therefore, Tj for an ambient temperature of 70°C with all outputs switching is:

 $70^{\circ}\text{C} + 0.304\text{W} * 66.6^{\circ}\text{C/W} = 90.2^{\circ}\text{C}$. This is well below the limit of 125°C.

This calculation is only an example. Tj will obviously vary depending on the number of loaded outputs, supply voltage, air flow and the type of board (single layer or multi-layer).

Table 6. Thermal Resistance θ_{JA} for 20 Lead TSSOP, Forced Convection

	θ_{JA} by Velocity		
Linear Feet per Minute	0	200	500
Single-Layer PCB, JEDEC Standard Test Boards	114.5°C/W	98.0°C/W	88.0°C/W
Multi-Layer PCB, JEDEC Standard Test Boards	73.2°C/W	66.6°C/W	63.5°C/W

3. Calculations and Equations.

The purpose of this section is to derive the power dissipated into the load.

HSTL output driver circuit and termination are shown in Figure 6.

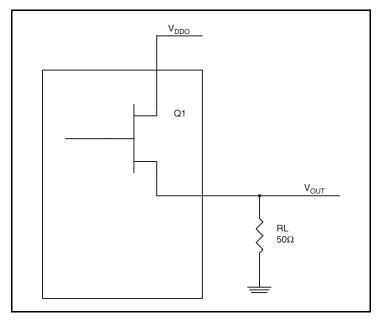


Figure 6. HSTL Driver Circuit and Termination

To calculate worst case power dissipation into the load, use the following equations which assume a 50Ω load.

Pd_H is power dissipation when the output drives high.

Pd_L is the power dissipation when the output drives low.

$$Pd_{-}H = (V_{OH_MAX}/R_{L}) * (V_{DDO_MAX} - V_{OH_MAX})$$

$$Pd_{-}L = (V_{OL_MAX}/R_{L}) * (V_{DDO_MAX} - V_{OL_MAX})$$

$$Pd_H = (0.9V/50\Omega) * (2V - 0.9V) = 19.8mW$$

 $Pd_L = (0.4V/50\Omega) * (2V - 0.4V) = 12.8mW$

Total Power Dissipation per output pair = Pd_H + Pd_L = 32.6mW

Reliability Information

Table 7. θ_{JA} vs. Air Flow Table for a 20 Lead TSSOP

θ_{JA} by Velocity						
Linear Feet per Minute	0	200	500			
Single-Layer PCB, JEDEC Standard Test Boards	114.5°C/W	98.0°C/W	88.0°C/W			
Multi-Layer PCB, JEDEC Standard Test Boards	73.2°C/W	66.6°C/W	63.5°C/W			

Transistor Count

The transistor count for ICS8523 is: 472

Package Outline and Package Dimension

Package Outline - G Suffix for 20 Lead TSSOP

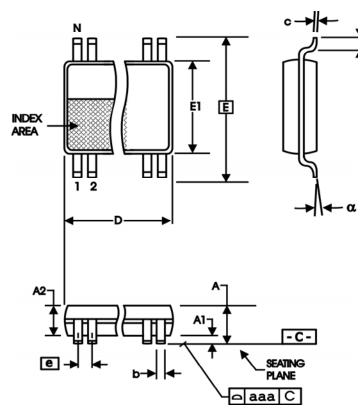


Table 7. Package Dimensions

All Dimensions in Millimeters				
Symbol	Symbol Minimum Maximu			
N	20			
Α		1.20		
A 1	0.05	0.15		
A2	0.80	1.05		
b	0.19	0.30		
С	0.09	0.20		
D	6.40	6.60		
Е	6.40 Basic			
E1	4.30	4.50		
е	0.65 Basic			
L	0.45	0.75		
α	0°	8°		
aaa		0.10		

Reference Document: JEDEC Publication 95, MO-153

Ordering Information

Table 8. Ordering Information

Part/Order Number	Marking	Package	Shipping Packaging	Temperature
8523CG	ICS8523CG	20 Lead TSSOP	Tube	0°C to 70°C
8523CGT	ICS8523CG	20 Lead TSSOP	2500 Tape & Reel	0°C to 70°C
8523CGLF	ICS8523CGLF	"Lead-Free" 20 Lead TSSOP	Tube	0°C to 70°C
8523CGLFT	ICS8523CGLF	"Lead-Free" 20 Lead TSSOP	2500 Tape & Reel	0°C to 70°C

NOTE: Parts that are ordered with an "LF" suffix to the part number are the Pb-Free configuration and are RoHS compliant.

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Revision History Sheet

Rev	Table	Page	Description of Change		
	T4D	5	HSTL table - added V _{SWING} row to HSTL DC Characteristics Table.		
B T5 5		5	AC Characteristics table - t_{PD} row, added value of 1.3ns to Min.; changed Max. from 2.0ns to 1.6ns.	7/31/01	
В		3	Updated Figure 1, CLK_EN Timing Diagram.	10/17/01	
В		3	Updated Figure 1, CLK_EN Timing Diagram.	11/2/01	
С	T5	5	AC Characteristics table - t _{PD} row, changed Min. from 1.3ns to 1.0ns. tsk(pp) row, changed Max. from 150ps to 200ps.	1/11/02	
С		1	Revised Features section, Bullet 1,6 - took out 1.8V	5/6/02	
С		8-10	In the Application Information section, added Schematic Examples.	10/25/02	
	T2	2	Pin Characteristics Table - changed C _{IN} 4pF max. to 4pF typical.		
		4	Absolute Maximum Ratings - changed Output rating.		
С	T4D	5	HSTL DC Characteristics Table - changed V _{OH} 1V min. to 0.9V min.	6/20/03	
C		11 - 12	Power Considerations - changed Total Power Dissipation to reflect V _{OH} change.	6/20/03	
			Calculations changed due to new Total Power Dissipation.		
			Changed LVHSTL to HSTL throughout data sheet.		
		1	Features section - added Lead-Free bullet.		
С		9	Updated LVPECL Clock Input Interface section.	9/13/04	
	Т9	15	Added Lead-Free marking to Ordering Information table.		
С	Т8	16	Ordering Information Table - in the <i>Part/Order Number</i> and <i>Marking</i> columns, changed die revision from "B" to "C".		
D	T5	6	AC Characteristics Table - changed t _R /t _F minimum from 300ps to 250ps.	3/13/07	

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Corporate Headquarters

Integrated Device Technology, Inc. 6024 Silver Creek Valley Road San Jose, CA 95138 United States 800 345 7015 +408 284 8200 (outside U.S.)

Asia Pacific and Japan

Integrated Device Technology Singapore (1997) Pte. Ltd. Reg. No. 199707558G 435 Orchard Road #20-03 Wisma Atria Singapore 238877 +65 6 887 5505

Europe

IDT Europe, Limited 321 Kingston Road Leatherhead, Surrey KT22 7TU England +44 (0) 1372 363 339 Fax: +44 (0) 1372 378851



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